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Mail Stop Non-Fee Amendment Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Aug - Taran

Date: 17 September 2003

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Appl. No.:

09/989,477

Applicant(s): Johnson, et al.

Filed:

11/20/2001

Title:

OVERMOLDING ENCAPSULATION PROCESS AND ENCAPSULATED ARTICLE

MADE THEREFROM

Art Unit:

2829

Examiner:

Evan T. Pert

Docket No.:

DB000624-003

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

RESPONSE AND AMENDMENT

In response to the Office Action mailed 1 August 2003, please consider the instant Response and Amendment for the above-identified application.

Amendments to the Specification: None.

Amendments to the Claims are shown in the listing of claims which begins on page 2 of this paper.

Amendments to the Drawings: None.

Remarks/Arguments begin on page 3 of this paper.